

Li-Ion Charger Development System Control of On-Board PNP Switch-Mode Regulator

Features

- ➤ bq2054 fast-charge control evaluation and development, based on switching buck converter with low-side battery-current sensing
- ➤ On-board configuration for fast charge of 1, 2, 3, or 4 Li-Ion cells
- ➤ Charge termination by selectable minimum current, or maximum time-out
- ➤ Constant current (up to 1.25A) and constant voltage (up to 16.8V) provided by on-board switch-mode regulator
- ➤ Jumper-configurable LED display
- ➤ Direct connections for battery and thermistor
- ➤ Maximum charge time of 5 hours

General Description

The DV2054S2 Development System provides a development environment for the bq2054 Lithium Ion Fast-Charge IC. The DV2054S2 incorporates a bq2054 and a buck-type switch-mode regulator to provide fast charge control for 1 through 4 Li-Ion cells.

Fast charge is preceded by a pre-charge qualification pe-

Fast charge termination occurs on:

Minimum current – I_{MAX} divided by 10, 20, or 30

Maximum time-out

The bq2054 can be reset and a new charge cycle started by applicaton of power to the board or battery replacement.

The user provides a DC power supply and batteries and configures the board for the number of cells, the minimum current threshold, and the LED display mode. The board has direct connections for the battery and the provided thermistor.

Before using the DV2054S2 board, please review the bq2054 data sheet.



Connection Descriptions

	DC+	Charger supply positive (24VDC max.)
	DC-	Charger supply ground
J2		
	BAT+	Positive battery terminal
	TEM+	Postive thermistor connections
	BAT-	Negative battery terminal and thermistor connecton.
JP1		Display mode selection
JP2		Number of cells selection
JP3		Full and minimum current termination select

SLUU024-APRIL 1999 Rev. B Board

J1

Fixed Configuration

The DV2054S2 board has the following characteristics:

V_{CC} for the fast-charge IC is regulated onboard from the supply at connector J1.

J1 can accept a maximum of 25VDC.

LED indicates charge status.

Charge begins on the later application of

- The battery
- Supply voltage

The on-board regulator supplies a fast charge current I_{MAX} of 1.25A. The fast-charge voltage V_{MAX} is set at 25°C.

The switching frequency of the PWM control loops is $120 \mathrm{kHz}$.

The regulated current is controlled by the value of the sense resistor $R_{\rm SNS}$ according to the relationship

$$I_{\rm CHG} = \frac{0.250V}{R_{\rm SNS}}$$

The value of R_{SNS} (R17 in the schematic) at shipment is $0.200\Omega.$ This resistor can be changed depending on the application. The maximum charging current I_{MAX} for the DV2054S2 board is 1.25A.

The thermistor provided is a Philips 2322–640–63103. With this thermistor connected between TEM+ and BAT-, the temperature fault limits are $V_{\rm LTF}$ (low-temperature fault) = 0°C, $V_{\rm HTF}$ (high-temperature fault) = 45°C, and $V_{\rm TCO}$ (charge cutoff) = 47°C.

Jumper-Selectable Configuration

The DV2054S2 can be configured as follows (see Jumber Configuration Diagram for location of the jumbers):

JP1: Configures the display mode (DSEL).

JP1	Display Mode
[1 2] 3	Mode 1
1 [2 3]	Mode 2
1 2 3	Mode 3

JP2: Configures the board for the number of cells.

JP2	Number of Cells
[12]345678	1
1 2 [3 4] 5 6 7 8	2
1 2 3 4 [5 6] 7 8	3
1 2 3 4 5 6 [7 8]	4

JP3: Sets the minimum current termination.

JP3	I _{MIN}
[1 2] 3	$I_{MAX}/10$
1 [2 3]	$I_{MAX}/_{20}$
123	$I_{MAX}/30$

Setup Procedure

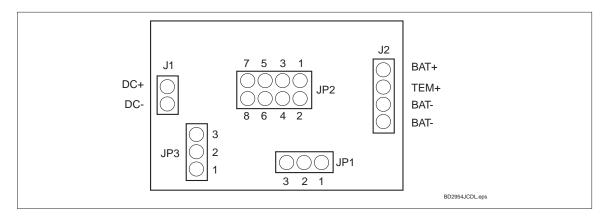
- Connect the thermistor to TEM+ and BAT-.
- 2. Attach the battery pack to BAT+ and BAT-.
- 3. Connect the charging supply to J1.

The following table shows the minimum input requirement for a given number of cells.

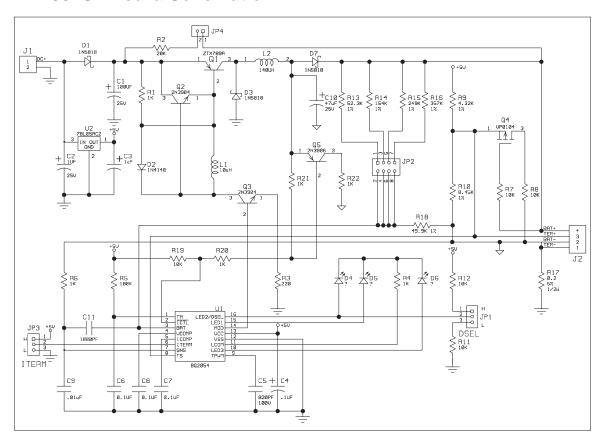
Number of Cells	Minimum Charger Supply Input
1	8.5VDC
2	13VDC
3	19VDC
4	25VDC

The combined charging and system load should not exceed the I_{MAX} limit of 1.25A.

Jumper Configuration Diagram



DV2054S2 Board Schematic



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